



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/647,297                      Group Art Unit: 1794  
Filing Date: August 26, 2003              Examiner: Hai Vo  
Applicants: Hyun HUH et al.  
Title: POLISHING PAD CONTAINING EMBEDDED LIQUID  
MICROELEMENTS AND METHOD OF  
MANUFACTURING THE SAME  
Attorney Docket: 47881-000003/US

Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

March 28, 2008

OK TO ENTER: /HV/

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04/10/2008

**AMENDMENT UNDER 35 U.S.C. §1.116**

Sir:

In response to the Final Office Action mailed January 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

**Amendments to the Claims** begins on page 2 of this Amendment.

**Remarks** begin on page 7 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
<b>Total</b>	15	-	31	=	0
<b>Independent</b>	1	-	3	=	0